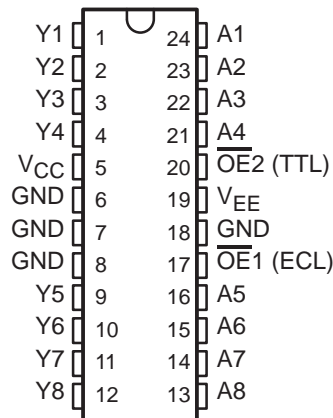


SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

SDZS003A – OCTOBER 1989 – REVISED OCTOBER 1990

- 10KH Compatible
- ECL and TTL Control Inputs
- Noninverting Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Center Pin V_{CC} , V_{EE} , and GND Configurations Minimize High-Speed Switching Noise
- Package Options Include “Small Outline” Packages and Standard Plastic 300-mil DIPs

**DW OR NT PACKAGE
(TOP VIEW)**



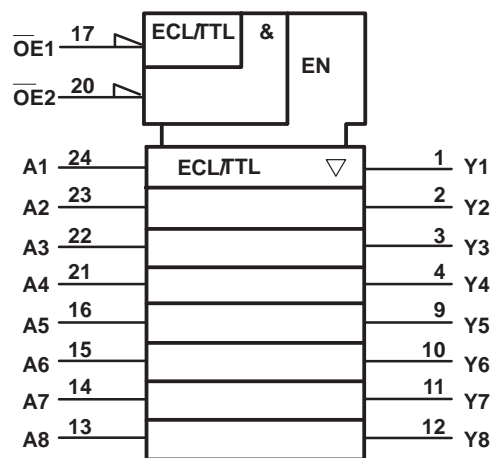
description

This octal ECL-to-TTL translator is designed to provide a efficient translation between a 10KH ECL signal environment and a TTL signal environment. This device is designed specifically to improve the performance and density of ECL-to-TTL CPU/bus-oriented functions such as memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

Two output-enable pins, $\overline{OE1}$ and $\overline{OE2}$, are provided. These control inputs are ANDed together with $\overline{OE1}$ being ECL compatible and $\overline{OE2}$ being TTL compatible. This offers the choice of controlling the outputs of the device from either a TTL or ECL signal environment.

The SN10KHT5541 is characterized for operation from 0°C to 75°C.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

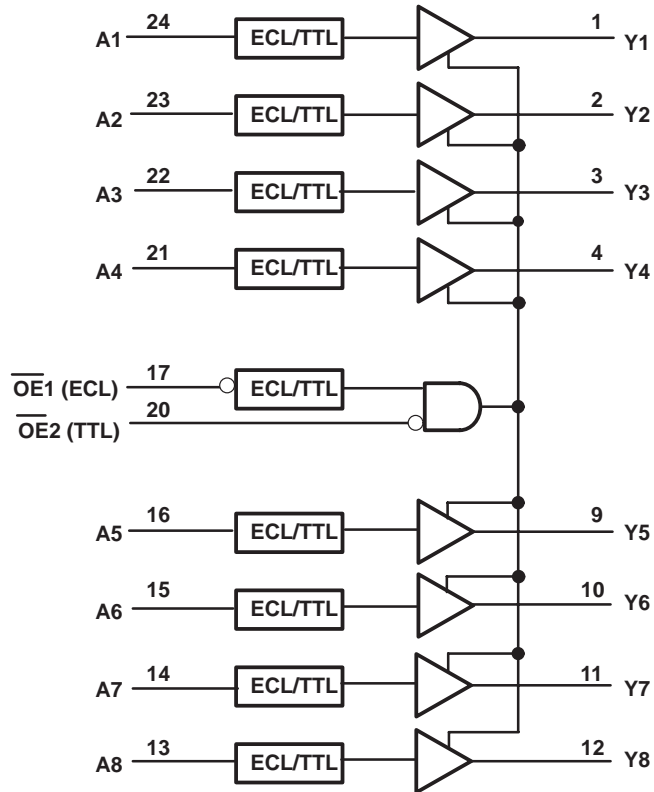
FUNCTION TABLE

OUTPUT ENABLE		DATA INPUT A	OUTPUT (TTL)
$\overline{OE1}$	$\overline{OE2}$		Y
X	H	X	Z
H	X	X	Z
L	L	L	L
L	L	H	H

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logic diagram (positive logic)



SN10KHT5541
OCTAL ECL-TO-TTL TRANSLATOR
WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC}	-0.5 V to 7 V
Supply voltage, V_{EE}	-8 V to 0 V
Input voltage (TTL) (see Note 1)	-1.2 V to 7 V
Input voltage (ECL)	V_{EE} to 0 V
Voltage applied to any output in the disabled or power-off state	-0.5 V to 5.5 V
Voltage applied to any output in the high state	-0.5 V to V_{CC}
Input current (TTL)	-30 mA to 5 mA
Current into any output in the low state	96 mA
Operating free-air temperature range	0°C to 75°C
Storage temperature range	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The TTL input voltage ratings may be exceeded provided the input current ratings are observed.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	TTL supply voltage	4.5	5	5.5	V
V_{EE}	ECL supply voltage	-4.94	-5.2	-5.46	V
V_{IH}	TTL high-level input voltage	2			V
V_{IL}	TTL low-level input voltage			0.8	V
V_{IH}^{\ddagger}	ECL high-level input voltage	$T_A = 0^\circ\text{C}$		-840	mV
		$T_A = 25^\circ\text{C}$	-1130	-810	
		$T_A = 75^\circ\text{C}$	-1070	-735	
V_{IL}^{\ddagger}	ECL low-level input voltage	$T_A = 0^\circ\text{C}$	-1950	-1480	mV
		$T_A = 25^\circ\text{C}$	-1950	-1480	
		$T_A = 75^\circ\text{C}$	-1950	-1450	
I_{IK}	TTL input clamp current			-18	mA
I_{OH}	High-level output current			-15	mA
I_{OL}	Low-level output current			48	mA
T_A	Operating free-air temperature	0		75	°C

‡ The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic levels only.



SN10KHT5541

OCTAL ECL-TO-TTL TRANSLATOR

WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V _{IK}	$\overline{OE}2$ only	V _{CC} = 4.5 V, V _{EE} = -4.94 V, I _I = -18 mA				-1.2	V
I _I	$\overline{OE}2$ only	V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = 7 V				0.1	mA
I _{IH}	$\overline{OE}2$ only	V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = 2.7 V				20	μA
I _{IL}	$\overline{OE}2$ only	V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = 0.5 V				-0.5	mA
I _{IH}	Data inputs and $\overline{OE}1$	V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = -840 mV	T _A = 0°C			350	μA
		V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = -810 mV	T _A = 25°C			350	
		V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = -735 mV	T _A = 75°C			350	
I _{IL}	Data inputs and $\overline{OE}1$	V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _I = -1950 mV	T _A = 0°C	0.5			μA
			T _A = 25°C	0.5			
			T _A = 75°C	0.5			
V _{OH}		V _{CC} = 4.5 V, V _{EE} = -5.2 V ± 5%, I _{OH} = -3 mA		2.4	3.3		V
		V _{CC} = 4.5 V, V _{EE} = -5.2 V ± 5%, I _{OH} = -15 mA		2	3.1		
V _{OL}		V _{CC} = 4.5 V, V _{EE} = -5.2 V ± 5%, I _{OL} = 48 mA		0.38	0.55		V
I _{OZH}		V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _O = 2.7 V				50	μA
I _{OZL}		V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _O = 0.5 V				-50	μA
I _{OS} [‡]		V _{CC} = 5.5 V, V _{EE} = -5.46 V, V _O = 0		-100		-225	mA
I _{CCH}		V _{CC} = 5.5 V, V _{EE} = -5.46 V			64	97	mA
I _{CCL}		V _{CC} = 5.5 V, V _{EE} = -5.46 V			80	120	mA
I _{CCZ}		V _{CC} = 5.5 V, V _{EE} = -5.46 V			77	116	mA
I _{EE}		V _{CC} = 5.5 V, V _{EE} = -5.46 V			-22	-33	mA
C _i		V _{CC} = 5 V, V _{EE} = -5.2 V			5		pF
C _o		V _{CC} = 5 V, V _{EE} = -5.2 V			7		pF

[†] All typical values are at V_{CC} = 5 V, V_{EE} = -5.2 V, T_A = 25°C.

[‡] Not more than one output should be tested at a time and the duration of the test should not exceed 10 ms.

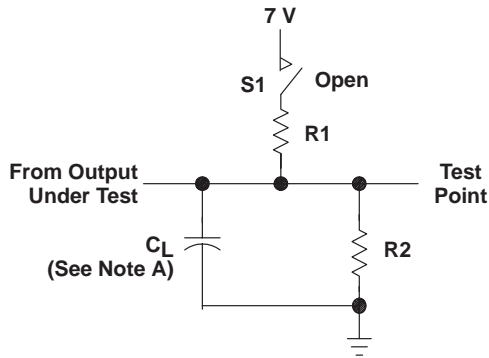
switching characteristics over recommended ranges of operating free-air temperature and supply voltage (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L = 50 pF, R ₁ = 500 Ω, R ₂ = 500 Ω			UNIT
			MIN	TYP [§]	MAX	
t _{PLH}	A	Y	1.7	4	6.2	ns
t _{PHL}			1.6	4	6.2	
t _{PZH}	$\overline{OE}1$	Y	2.6	4.7	6.7	ns
t _{PZL}			3.2	5.9	8.5	
t _{PHZ}	$\overline{OE}1$	Y	2.9	5.4	7.8	ns
t _{PLZ}			1.9	4.9	7.8	
t _{PZH}	$\overline{OE}2$	Y	1.7	4	6.2	ns
t _{PZL}			2.5	5.1	7.7	
t _{PHZ}	$\overline{OE}2$	Y	2.1	4.3	6.4	ns
t _{PLZ}			1.1	3.7	6.3	

[§] All typical values are at V_{CC} = 5 V, V_{EE} = -5.2 V, T_A = 25°C.



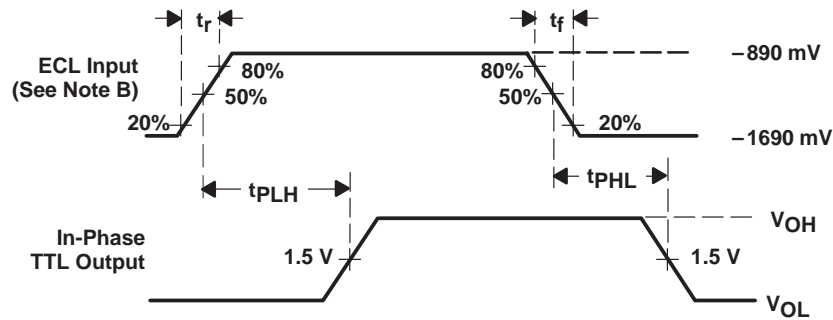
PARAMETER MEASUREMENT INFORMATION



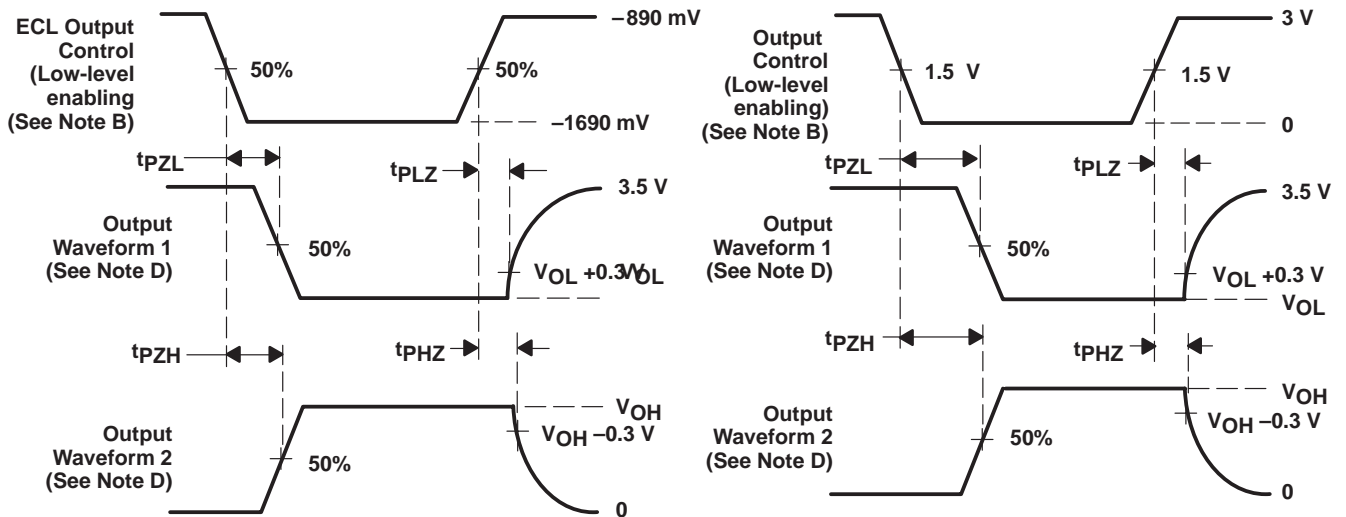
SWITCH POSITION TABLE

TEST	S1
t _{PLH}	Open
t _{PHL}	Open
t _{PZH}	Open
t _{PZL}	Closed
t _{PHZ}	Open
t _{PLZ}	Closed

LOAD CIRCUIT



ECL- INPUT PROPAGATION DELAY TIMES



ECL ENABLE AND DISABLE TIMES

TTL ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
 B. For TTL inputs, input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_0 = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 C. For ECL inputs, input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_0 = 50 \Omega$, $t_r \leq 0.7$ ns, $t_f \leq 0.7$ ns.
 D. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 E. The outputs are measured one at a time with one transition per measurement.

FIGURE 1. LOAD CIRCUIT AND VOLTAGE WAVEFORMS

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN10KHT5541DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN10KHT5541NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN10KHT5541NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

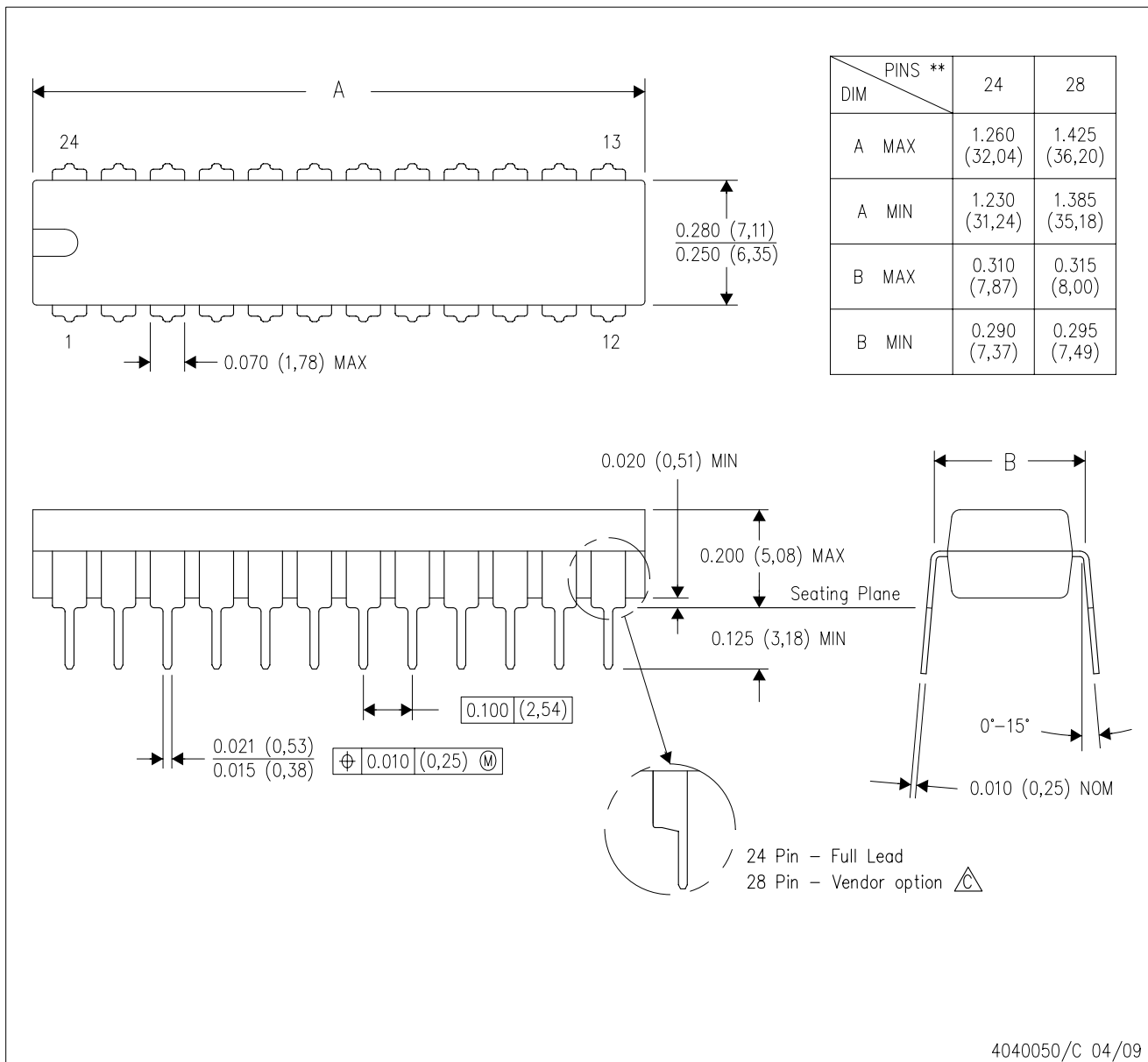
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MECHANICAL DATA

NT (R-PDIP-T**) 24 PINS SHOWN

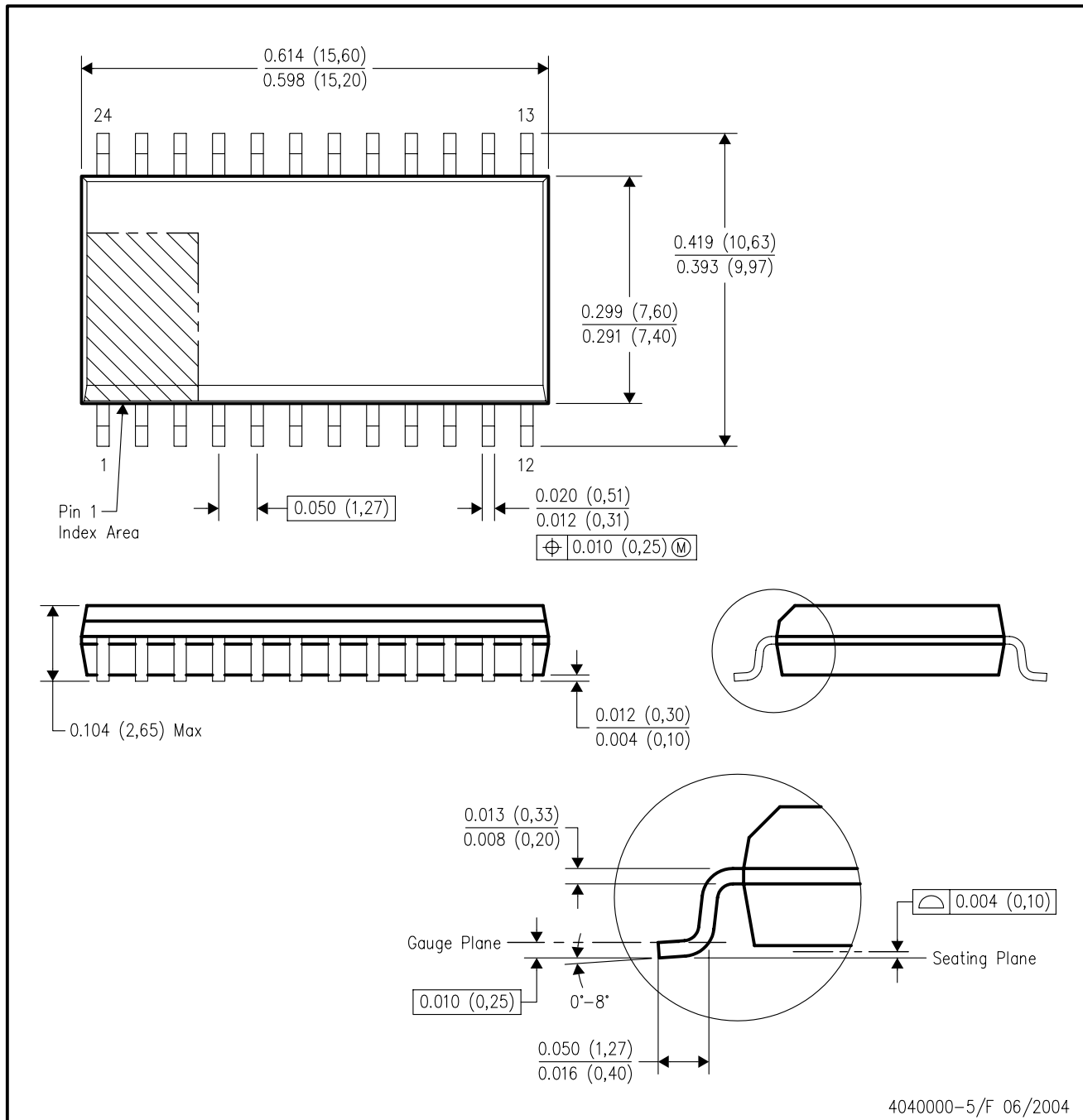
PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 -  The 28 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AD.

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